

NPN SILICON RF TRANSISTOR 2SC4536

NPN EPITAXIAL SILICON RF TRANSISTOR FOR HIGH-FREQUENCY LOW-NOISE AMPLIFICATION 3-PIN POWER MINIMOLD

DESCRIPTION

The 2SC4536 is designed for use in middle power, low distortion low noise figure RF amplifier. It features excellent linearity and large dynamic range, which make it suitable for CATV, telecommunication, and other use, it employs plastic surface mount type package (SOT-89).

FEATURES

- Low distortion: IM₂ = 59.0 dBc TYP., IM₃ = 82.0 dBc TYP. @ VcE = 10 V, Ic = 50 mA
- Low noise: NF = 2.0 dB TYP. @ Vc∈ = 10 V, Ic = 50 mA, f = 1 GHz
 - Large Ptot: Ptot = 2.0 W (Mounted on double-sided copper-clad 16 cm² × 0.7 mm (t) ceramic substrate)
 - · Small package: 3-pin power minimold package

★ ORDERING INFORMATION

Part Number	Quantity	Supplying Form	
2SC4536	25 pcs (Non reel)	• 12 mm wide embossed taping	
2SC4536-T1	1 kpcs/reel	Collector face the perforation side of the tape	

Remark To order evaluation samples, contact your nearby sales office.

The unit sample quantity is 25 pcs.

ABSOLUTE MAXIMUM RATINGS (TA = +25°C)

Parameter	Symbol	Ratings	Unit
Collector to Base Voltage	Vсво	30	V
Collector to Emitter Voltage	Vceo	15	V
Emitter to Base Voltage	V _{ЕВО}	3.0	V
Collector Current	lc	250	mA
Total Power Dissipation	Ptot Note	2.0	W
Junction Temperature	Tj	150	°C
Storage Temperature	T _{stg}	-65 to +150	°C

Note Mounted on double-sided copper-clad 16 cm $^2 \times 0.7$ mm (t) ceramic substrate

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version. Not all devices/types available in every country. Please check with local NEC Compound Semiconductor Devices representative for availability and additional information.

Document No. PU10338EJ01V0DS (1st edition) (Previous No. P10369EJ2V1DS00) Date Published May 2003 CP(K)

The mark ★ shows major revised points.

Printed in Japan



ELECTRICAL CHARACTERISTICS (TA = +25°C)

	Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
	DC Characteristics						
	Collector Cut-off Current	Ісво	VcB = 20 V, IE = 0 mA	-	-	5.0	μΑ
	Emitter Cut-off Current	ІЕВО	VEB = 2 V, Ic = 0 mA	-	-	5.0	μΑ
*	DC Current Gain	hfe Note 1	VcE = 10 V, Ic = 50 mA	60	-	200	1
	RF Characteristics						
*	Insertion Power Gain	S _{21e} ²	Vce = 10 V, Ic = 50 mA, f = 1 GHz	5.5	7.2	1	dB
	Noise Figure (1)	NF Note 2	Vce = 10 V, Ic = 50 mA, f = 500 MHz	ı	1.5	1	dB
	Noise Figure (2)	NF Note 2	Vce = 10 V, Ic = 50 mA, f = 1 GHz	ı	2.0	1	dB
*	2nd Order Intermoduration Distortion	IM ₂	$\begin{aligned} &\text{VCE} = 10 \text{ V, Ic} = 50 \text{ mA, Rs} = \text{RL} = 75 \Omega, \\ &\text{Vo} = 105 \text{ dB}\mu\text{V}/75 \Omega, f_1 = 190 \text{ MHz}, \\ &\text{f}_2 = 90 \text{ MHz, }f = f_1 - f_2 \end{aligned}$	-	59.0	-	dBc
*	3rd Order Intermoduration Distortion	IMз	$\begin{split} \text{Vce} &= 10 \text{ V, Ic} = 50 \text{ mA, Rs} = \text{RL} = 75 \Omega, \\ \text{Vo} &= 105 \text{ dB}\mu\text{V/75 }\Omega, f_1 = 190 \text{ MHz}, \\ \text{f}_2 &= 200 \text{ MHz}, f = 2 \times \text{f}_1 - \text{f}_2 \end{split}$	-	82.0	ı	dBc

Notes 1. Pulse measurement: PW \leq 350 μ s, Duty Cycle \leq 2%

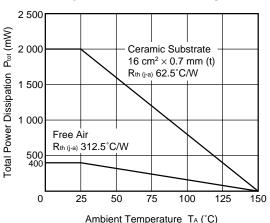
2. Rs = RL = 50Ω , tuned

★ hfe CLASSIFICATION

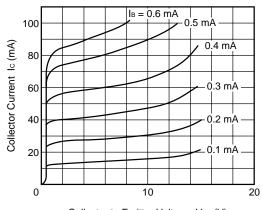
Rank	QR	QS		
Marking	QR	QS		
h _{FE} Value	60 to 120	100 to 200		

TYPICAL CHARACTERISTICS (TA = +25°C)

TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE

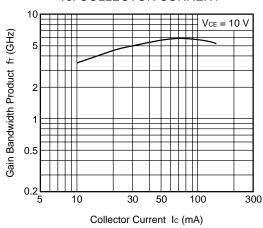


COLLECTOR CURRENT vs. COLLECTOR TO EMITTER VOLTAGE

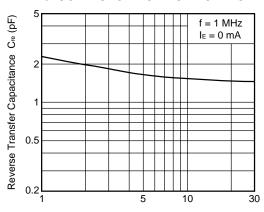


Collector to Emitter Voltage VcE (V)

GAIN BANDWIDTH PRODUCT vs. COLLECTOR CURRENT

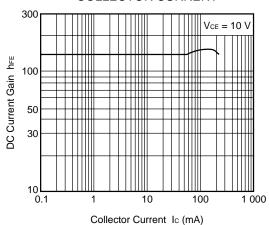


REVERSE TRANSFER CAPACITANCE vs. COLLECTOR TO BASE VOLTAGE

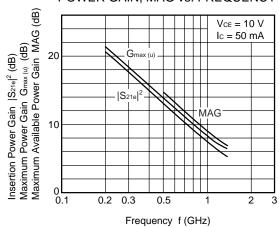


Collector to Base Voltage VcB (V)

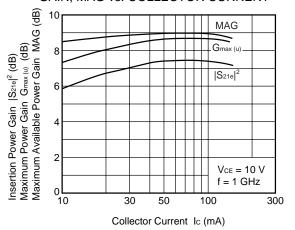
DC CURRENT GAIN vs. **COLLECTOR CURRENT**



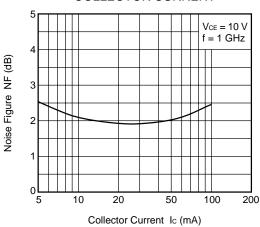
INSERTION POWER GAIN, MAXIMUM POWER GAIN, MAG vs. FREQUENCY

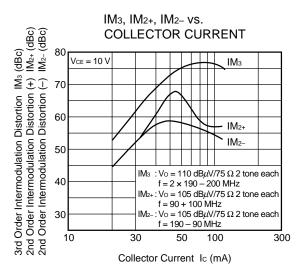


INSERTION POWER GAIN, MAXIMUM POWER GAIN, MAG vs. COLLECTOR CURRENT



NOISE FIGURE vs. COLLECTOR CURRENT





Remark The graphs indicate nominal characteristics.

S-PARAMETERS

S-parameters/Noise parameters are provided on the NEC Compound Semiconductor Devices Web site in a form (S2P) that enables direct import to a microwave circuit simulator without keyboard input.

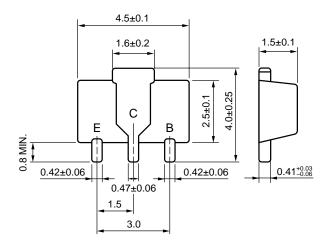
Click here to download S-parameters.

[RF and Microwave] → [Device Parameters]

URL http://www.csd-nec.com/

★ PACKAGE DIMENSIONS

3-PIN POWER MINIMOLD (UNIT: mm)



PIN CONNECTIONS

E : Emitter

C: Collector (Fin)

B : Base

(IEC: SOT-89)

- The information in this document is current as of May, 2003. The information is subject to change without notice. For actual design-in, refer to the latest publications of NEC's data sheets or data books, etc., for the most up-to-date specifications of NEC semiconductor products. Not all products and/or types are available in every country. Please check with an NEC sales representative for availability and additional information.
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M8E 00.4-0110

NEC 2SC4536

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